SOLON Corporation Potential Induced Degradation William Richardson NREL PVRW, February 1th, 2011

Don't leave the planet to the stupid

SOLON at a Glance



- One of the largest manufacturers of solar modules in Europe
- Large scale rooftop and greenfield installations
- Founded in 1997
- Production sites in Germany, Italy and the U.S.
- Employees: approx. 900



SOLON Corporation at a Glance



- 80 MW of annual manufacturing capacity in Tucson, AZ
- Large scale rooftop and Utility-scale installations
- Founded in 2007
- Wholly-owned subsidiary of SOLON SE
- Employees: approx. 150



Solar modules

Power plants

Industrial rooftops









Content

- Introduction & Motivation
- Background & Approach
- Results
 - Cell level
 - Panel level
 - System level
- What's Next?
- Summary & Conclusion



Motivation

Objective: To make Solar Energy even more competitive

- → Reduction of \$/kWh
- \rightarrow Two approaches:
 - 1. Reduction of \$/kWp
 - \rightarrow Become as cheap as possible!
 - 2. Increase lifetime/ Decrease degradation
 - → Become as stable/long-lasting as possible!

 \rightarrow Both tracks have to be pursued in parallel ...



Potential Induced Degradation

- Power degradation due the exposure to an external potential
- External potential = Potential relative to ground
- → High Voltage Stress

Power Degradation caused by the exposure to a potential
 relative to ground, and dependent on its magnitude and sign

 \rightarrow Two cases: Reversible (Polarization)

Irreversible (Electro corrosion)



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Background

- First addressed by Hoffman and Ross (JPL) 1978: Impact of voltage-biased humidity exposure of solar panels on long term stability – "Bias Humidity test... as a candidate for module qualification"
- Prominent cases such as Sunpower's Polarization effect
- More recently NREL: Degradation caused by HVS not covered by IEC or UL standards right now
- Increasing importance because:
 - \rightarrow Increasing need to push down overall degradation
 - \rightarrow Increasing system voltages
 - \rightarrow Increasing variety of solar cell technologies





Objective: Minimizing / Avoiding PID

 \rightarrow On cell level



 \rightarrow On panel level



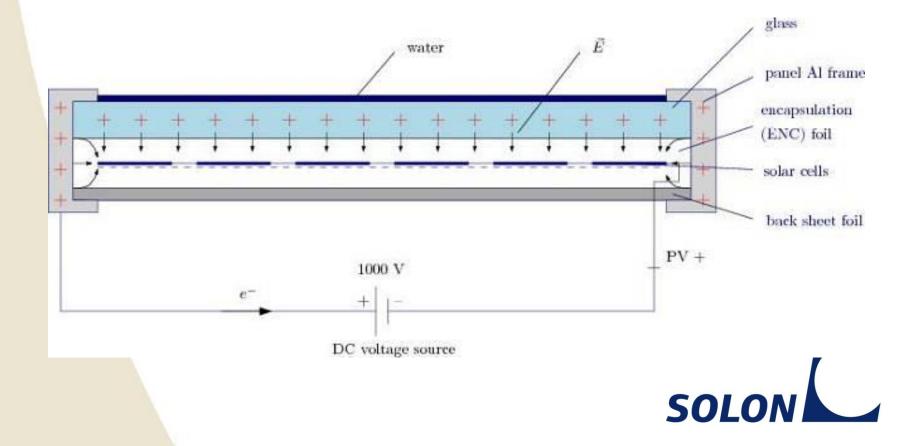
 \rightarrow On system level





Test Set up

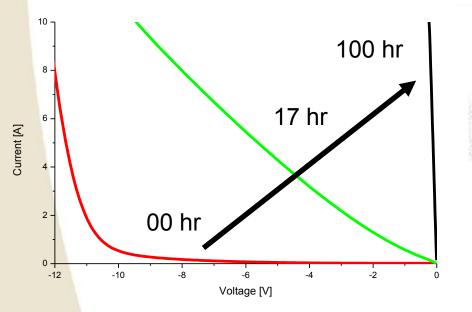
- Worst case scenario
- Simulation of potential relative to ground



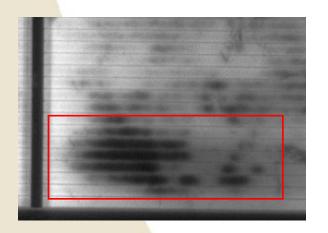
Content

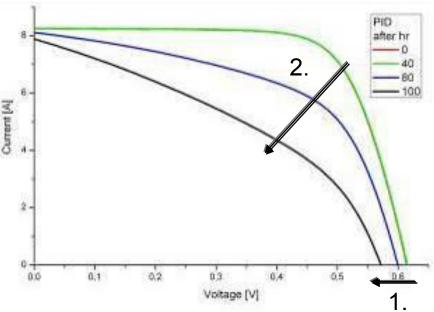
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Decrease of overall shunt resistance

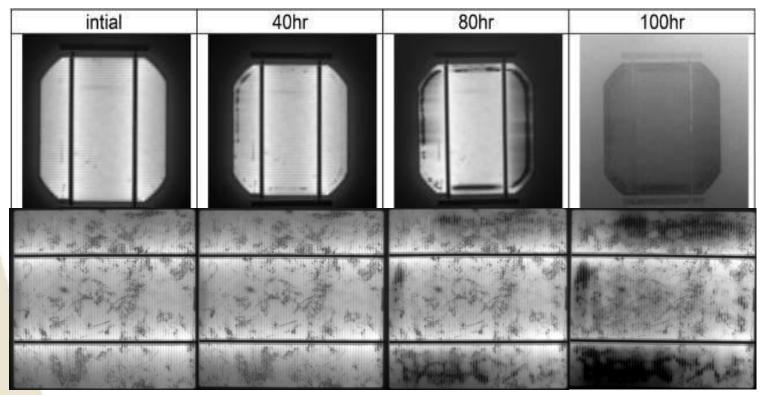




- →1. Loss FF
- \rightarrow 2. Loss in open circuit voltage

 \rightarrow Local short circuit of the pn-junction





EL images of a cell during PID test (1000V, 100h)

Tendency for PID very different for different cell manufacturers
→ Impact factors on cell level?



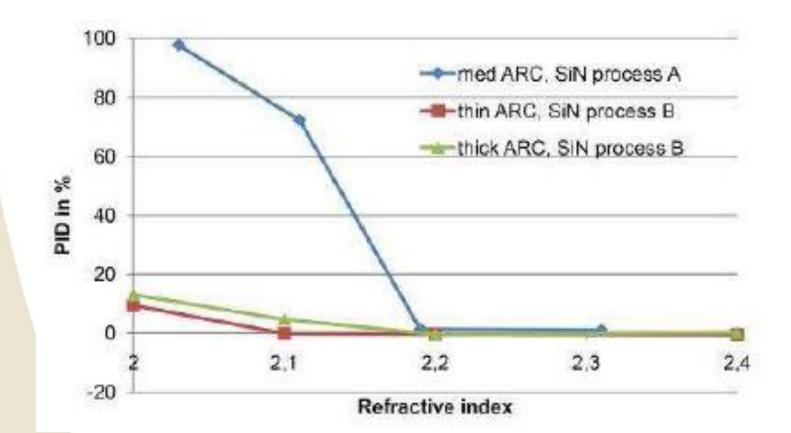
Impact factors:

- Base resistivity of wafer material \rightarrow significant influence
- Emitter sheet resistivity \rightarrow significant influence

■ ARC deposition → key feature

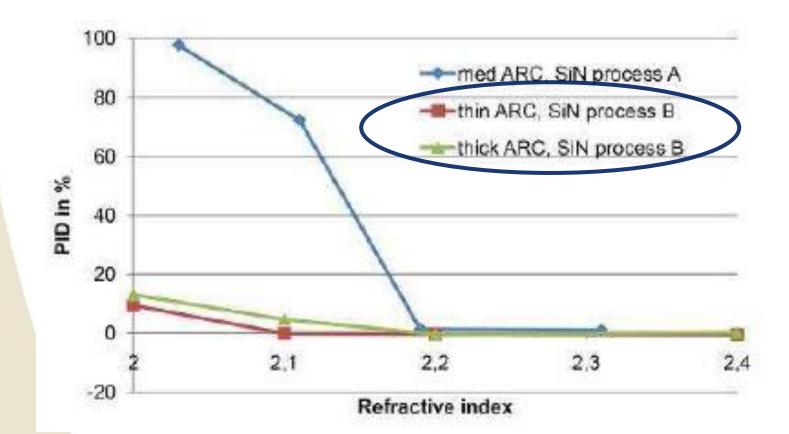
- Ratio of Si to N
- Thickness
- Homogeneity





By choosing suitable parameters for ARC deposition PID can be minimized/ stopped on cell level

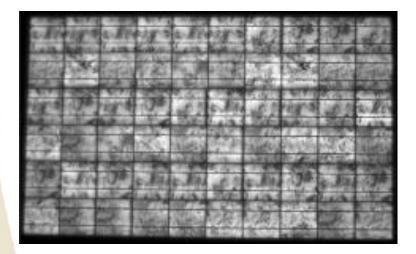




By choosing suitable parameters for ARC deposition PID can be minimized/ stopped on cell level



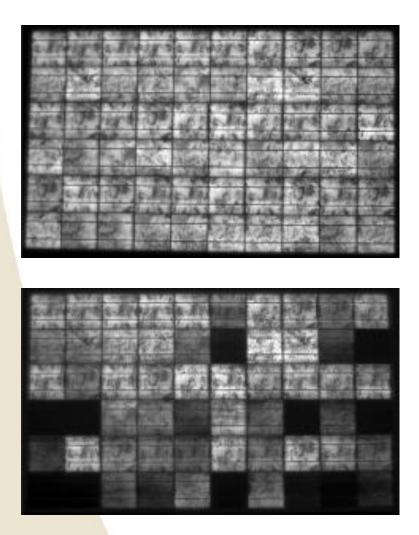
Panel level



EL image of a panel before 100hr 1000V PID...



Panel level



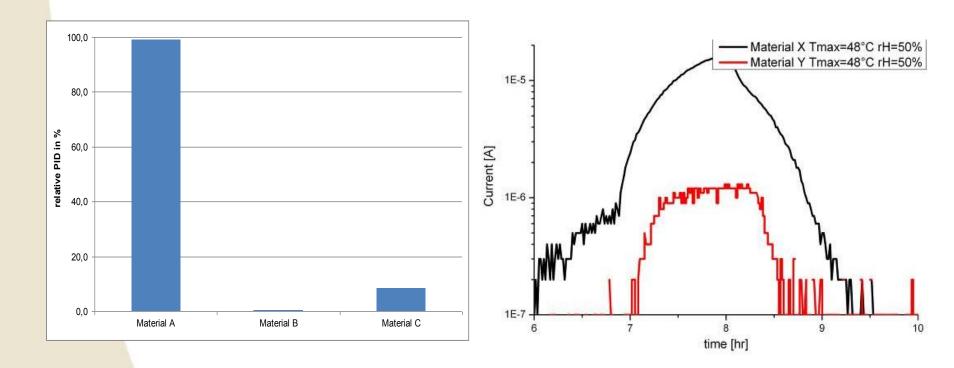
EL image of a panel before 100hr 1000V PID...

...and after.

Key feature: Leakage current



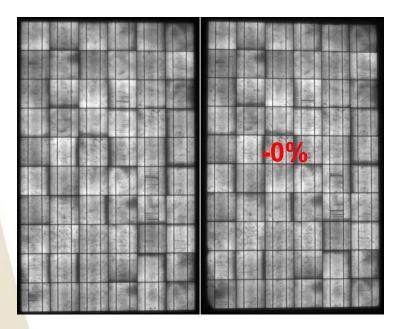
Panel level I



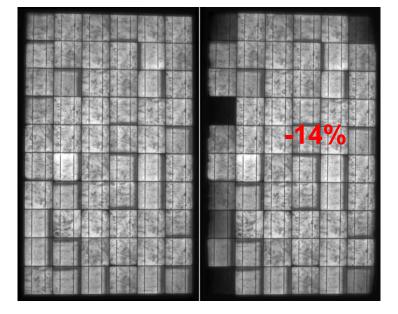
PID can be stopped/ minimized on panel level by minimizing leakage current \rightarrow Choice of suitable encapsulation



Panel level II

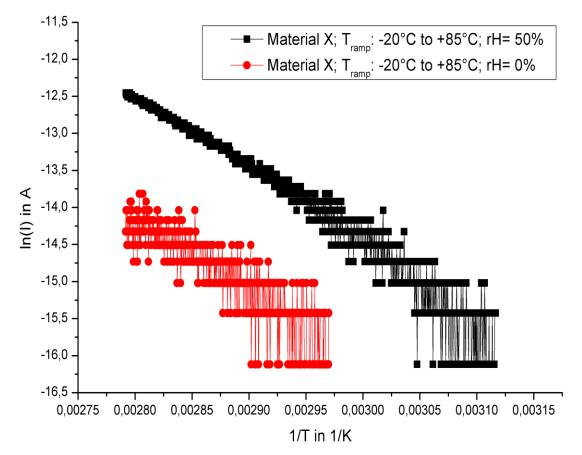


Time: 100h Voltage: 1000V Temperature: 48°C Humidity: 50% Material: X



Time: 100h Voltage: 1000V Temperature: 48°C Humidity: 50% Material: Y

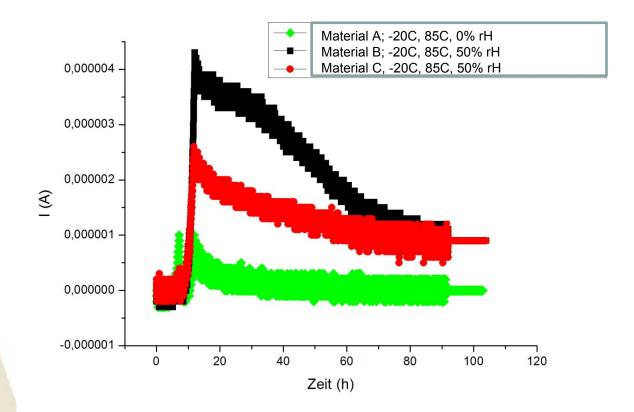
Panel level



Leakage current and cooresponding PID strongly dependent on temperature and humidity



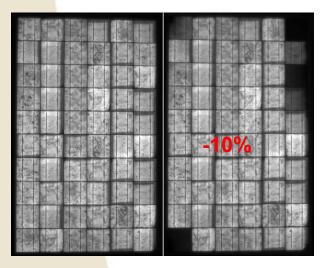
Panel level

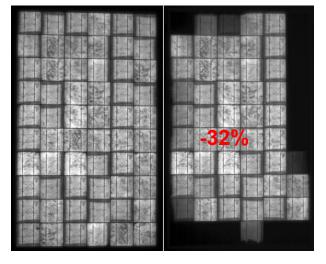


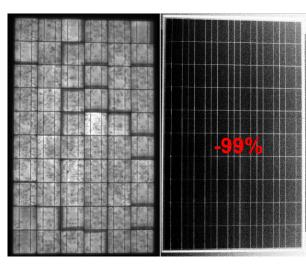
Leakage current and cooresponding PID strongly dependent on temperature and humidity



Temperature and humidity



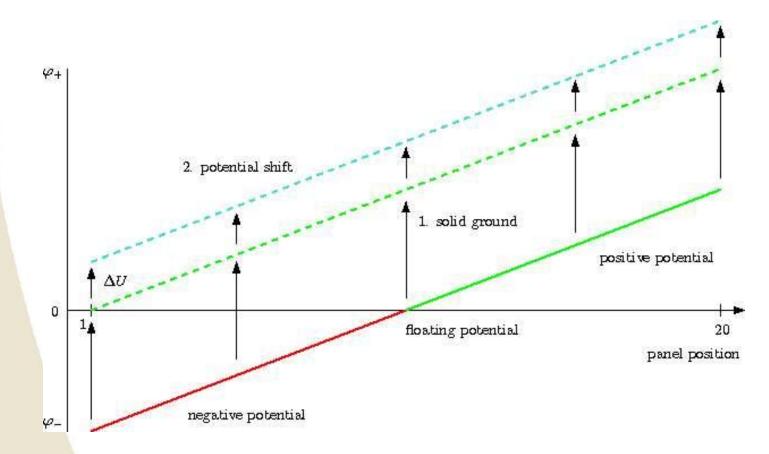




Time: 100h Voltage: 1000V Temperature: 85°C Humidity: ≈ 0%

Time: 100h Voltage: 1000V Temperature: 85°C Humidity: 50% Time: 100h Voltage: 1000V Temperature: 85°C Humidity: 100%

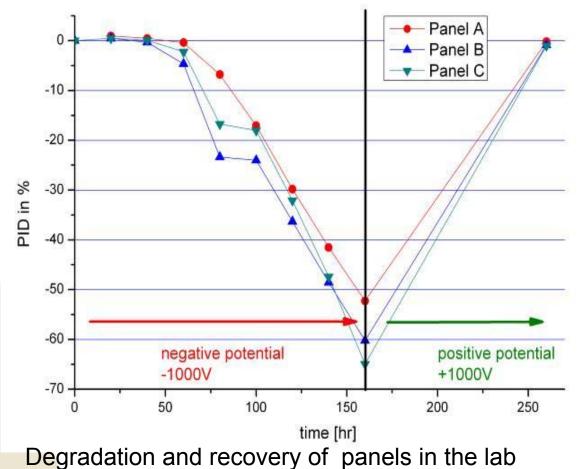
System level



 \rightarrow Potential relative to ground is determinded by grounding configuration



System level



PID can be stopped/ reversed by avoiding a negative potential → Suitable grounding configuration



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How do laboratory results correlate to real life?

The concept:

•2 different types of "laboratory proven" PID panels
•High PID tendency
•Low PID tendency
•3 different climatic regions

The need:

•3 identical test sites in 3 different regions



Global Test Site Network

Outdoor Test Sites and Proving Grounds

Providing the unique ability to test modules and related technologies in three distinct climatic regions

•3 Identical sites worldwide

•4 Components each site

- 1. Dual- Axis Tracker
- 2. Single Axis Tracker
- 3. Fixed -Tilt 32°
- 4. Fixed -Tilt 5°

•6 inverters each Component

Total Capacity: 72 individual strings

Individually Monitoring: DC Power AC Power

SOLON

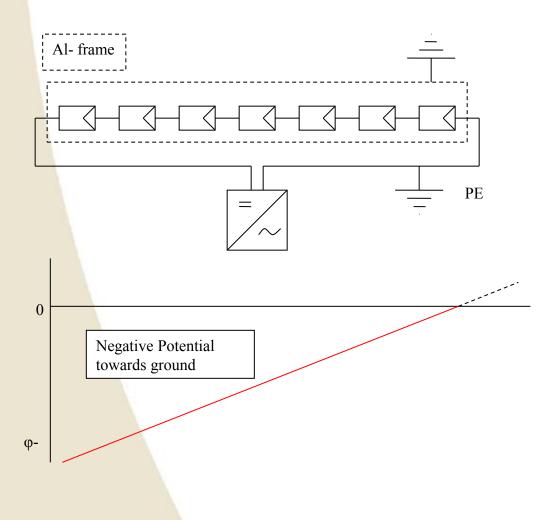
Irradiance (in plane & global) Ambient temp Cell temp Humidity Wind speed

Global Test Site Network – The Locations





Setup on test sites:



 3 test sites with identical system configuration and technology

•2 strings of 7 modules each site – total 6 strings

• Two different materials (high and low PID tendency)

•Positive pole is grounded to simulate the worst case scenario

• Meteorological stations log environmental conditions at the different test sites





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Solar Cell Level

→ Cooperation with different cell suppliers to modify the ARC according to cell spec

Module Level

→ Electrical characterization of encapsulation foils with high and low PID prevention

System Level

→Evaluating suitable inverter suppliers and proposed solutions



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Summary and Conclusion

- Origin of PID: Properties of solar cell
 → PID can be excluded/minimized on cell level
 → ARC
- Leakage current on panel level key feature for PID
 → PID can be excluded/ minimized on panel level
 → Encapsulation
- Sign and magnitude of the external potential critical for PID
 → PID can minimized on system level
 →Grounding
- Avoiding PID on panel level favourable since
 - \rightarrow Independent of cell technology
 - \rightarrow Independent of system / grounding configuration



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Thank you for your attention!

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